## **SIEMENS**

## **Data sheet**

## 6ES7590-0BH00-0AA0

SIMATIC S7-1500 / ET 200MP active backplane bus 8 slots for inserting S7-1500 I/O modules for hot swapping for use in the ET 200MP with IM 155-5 PN HF (from FW V4.4.1); S7-1500 mounting rail and slot covers to be ordered separately



Figure similar

General information	
Product type designation	Active Backplane ST 1+8 Slot
HW functional status	From FS01
Firmware version	V1.0.0
<ul> <li>FW update possible</li> </ul>	Yes
Product function	
<ul><li>I&amp;M data</li></ul>	Yes; I&M0 to I&M3
<ul> <li>Isochronous mode</li> </ul>	Yes
Prioritized startup	Yes
Engineering with	
<ul> <li>STEP 7 TIA Portal configurable/integrated from version</li> </ul>	V16
<ul> <li>STEP 7 configurable/integrated from version</li> </ul>	V5.6 and higher
<ul> <li>PROFINET from GSD version/GSD revision</li> </ul>	V2.35 / -
Power	
Power available from the backplane bus	2 W
Power loss	
Power loss, typ.	2 W
Hardware configuration	
Slots	
Grid size	35 mm; Utilization of 25 mm-wide modules possible
<ul> <li>Number of slots</li> </ul>	9
— of which for CPU, max.	0
<ul><li>of which for IM, max.</li></ul>	1
— of which for PS, max.	2; Max. 2 PS per station
<ul><li>— of which for IO/CM/CP/TM, max.</li></ul>	8
<ul><li>of which for F-IO, max.</li></ul>	8
<ul> <li>Number of single-width slots, max.</li> </ul>	8
Ambient conditions	
Ambient temperature during operation	
<ul> <li>horizontal installation, min.</li> </ul>	-30 °C
<ul> <li>horizontal installation, max.</li> </ul>	60 °C
<ul> <li>vertical installation, min.</li> </ul>	-30 °C
vertical installation, max.	40 °C
Ambient temperature during storage/transportation	
• min.	-40 °C
• max.	70 °C
Altitude during operation relating to sea level	
<ul> <li>Installation altitude above sea level, max.</li> </ul>	5 000 m; Restrictions for installation altitudes > 2 000 m, see manual
Dimensions	

Width	294 mm
Height Depth	99 mm
Depth	14 mm
Weights	
Weight, approx.	245 g

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